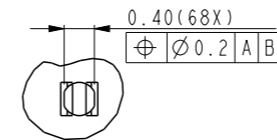
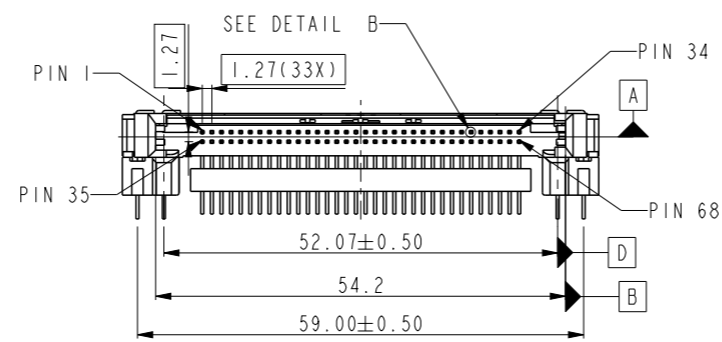
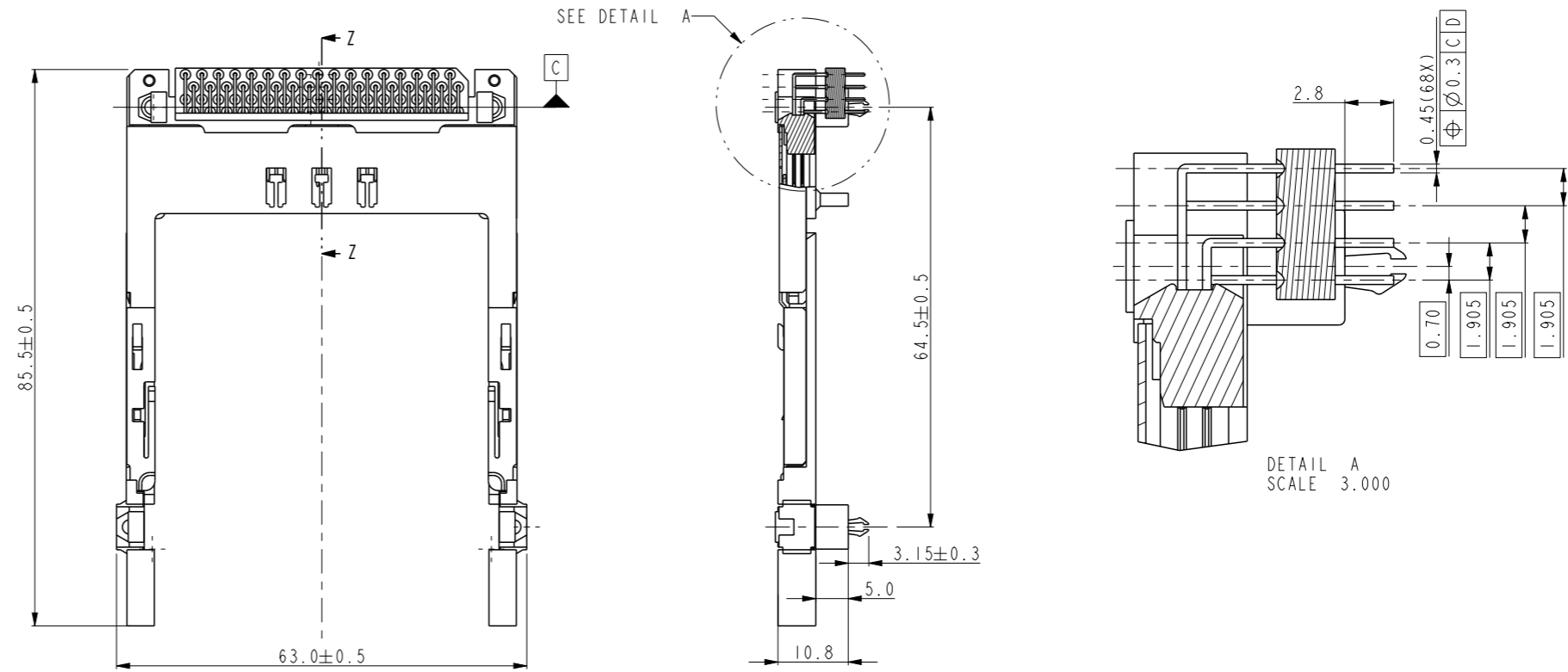


PRODUCT NO.
10118731-050HLF

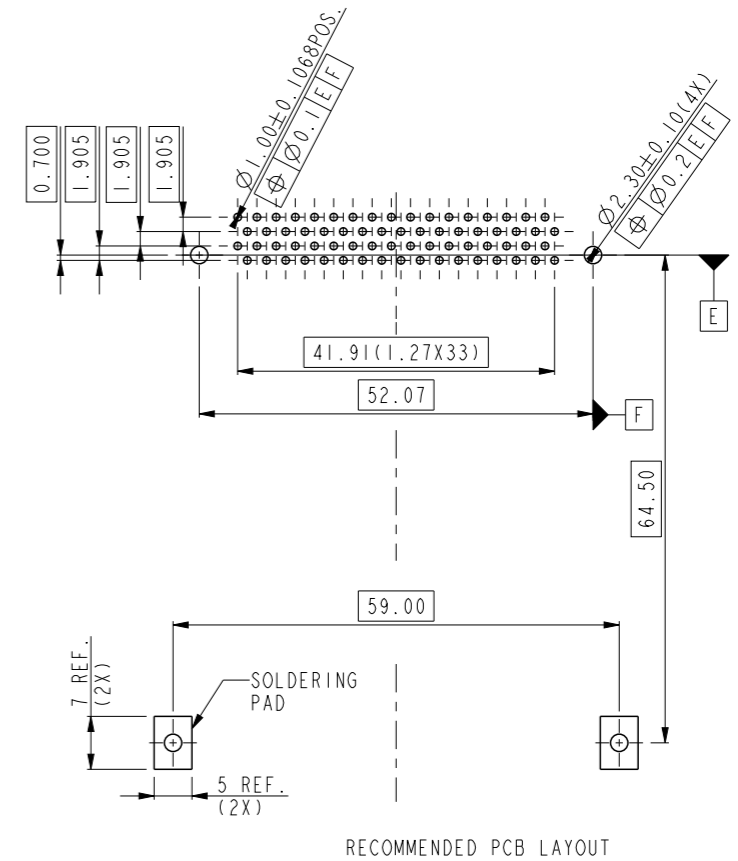
10118731 - X X X X LF

- LEAD FREE
- OPTION OF HOLF DOWN
NONE: NO
H: YES
- SOLDER TAIL
0: R/A
- STAND OFF
0: 0.0MM
5: 5.0MM
- MOUNTING STYLE
0: TOP MOUNTING
5: BOTTOM MOUNTING

CONTACT PIN LENGTH		
4.25±0.1	3.5±0.1	5.0±0.1
OTHERS	36, 37	1, 17, 34, 35, 51, 68



DETAIL B
SCALE 10.000



RECOMMENDED PCB LAYOUT

NOTES:

1. MATERIAL
HOUSING: HALOGEN FREE HIGH TEMPERATURE THERMOPLASTIC
TERMIAL: COPPER ALLOY
COVER: STAINLESS STEEL
2. FINISH(PIN)
a. ALL OVER: UNDER PLATING 1.27um Ni MIN.
b. CONTACT AREA: Au 0.076um MIN.
c. SOLDER AREA: 2.5um MIN. PURE TIN
3. THIS PRODUCT WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE FOR 10 SECONDS IN WAVE SOLDER APPLICATION WITH 1.0MM MIN.THICK CIRCUIT BOARD.
4. THIS PRODUCT MEETS EUROPEAN UNION DIREACTIVES AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.
5. PRODUCT SPEC: 110-263.

spec ref	-	dr	Su-Hua Miao	2012/07/11	projection	MM	size	A3	scale	1.000			
tolerance std	ISO 406 ISO 1101	eng	Su-Hua Miao	2012/07/16			ecn no	-	rel level	Released			
TOLERANCES UNLESS OTHERWISE SPECIFIED		chr	-	2012/07/18							product family	-	
surface	linear	0.X	±0.3		68P HF 3.3V NON EJECTOR HEADER ASSEMBLY		dwg no	10118731	rev	A			
		0.XX	±0.10		www.fci.com	cat. no.					-	Product - Customer Drw	sheet 1 of 1
	angular	0°	±2°										